

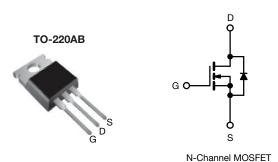
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Vishay Siliconix

COMPLIANT

HALOGEN

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V_{DS} (V) at T_J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.109				
Q _g max. (nC)	47				
Q _{gs} (nC)	12				
Q _{gd} (nC)	11				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP125N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 C, uni	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	600	V	
Gate-source voltage			V_{GS}	± 30	V	
Continuous drain augrent /T 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		25		
Continuous drain current (T _J = 150 °C)	VGS at 10 V	T _C = 100 °C	ID	16	Α	
Pulsed drain current ^a			I _{DM}	66		
Linear derating factor				1.4	W/°C	
Single pulse avalanche energy b			E _{AS}	88	mJ	
Maximum power dissipation			P_{D}	179	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		d. /dt	70	1//20		
Reverse diode dv/dt d			dv/dt	50	V/ns	
Soldering recommendations (peak temperature) c	For 10 s			260	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.5 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_{D}$, di/dt = 500 A/ μ s, starting T_{J} = 25 °C



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	0.7	C/VV

SPECIFICATIONS ($T_J = 25 ^{\circ}C$, t	ınless otherw	ise noted)					
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.67	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Cata assumas laskaga		,	V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zara gata valtaga drain aurrent	1	V _{DS} =	: 480 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 480 \text{ V}$	', V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.109	0.125	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 20 V, I _D = 12 A	-	6	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		1533	-	pF
Output capacitance	C _{oss}	Ţ ,			68	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	6	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V 0VI 400VV 0V		-	54	-	
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{DS} = 0$	V to 480 V, V _{GS} = 0 V	-	351	-	
Total gate charge	Qg			-	31	47	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 12 \text{ A}, V_{DS} = 480 \text{ V}$	-	12	-	nC
Gate-drain charge	Q _{gd}			-	11	-	
Turn-on delay time	t _{d(on)}			-	19	38	
Rise time	t _r	V _{DD} =	: 480 V, I _D = 12 A,	-	33	66	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		33	66	ns
Fall time	t _f			-	20	40	
Gate input resistance	Rg	f = 1 MHz, open drain		0.3	0.65	1.3	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	Is	showing the	MOSFET symbol showing the		-	25	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	66	A A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 12 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	117	234	ns
Reverse recovery charge	Q _{rr}	$T_{J} = 25$	$5 ^{\circ}\text{C}, I_F = I_S = 12 \text{A},$	-	0.7	1.4	μC
Reverse recovery current	I _{RRM}	di/dt = 100 A/μs, V _R = 400 V		-	11	-	A

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

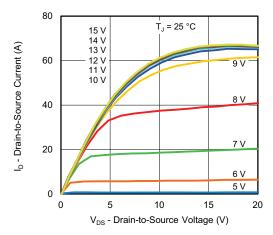


Fig. 1 - Typical Output Characteristics

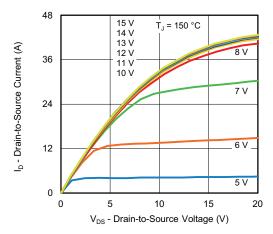


Fig. 2 - Typical Output Characteristics

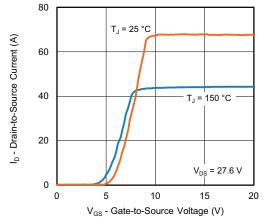


Fig. 3 - Typical Transfer Characteristics

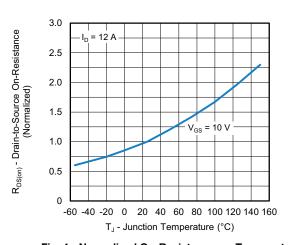


Fig. 4 - Normalized On-Resistance vs. Temperature

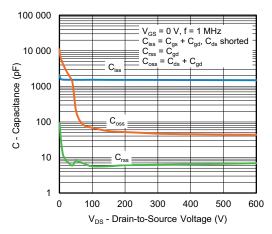


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

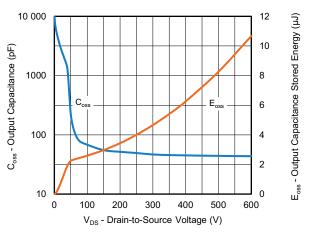


Fig. 6 - Coss and Eoss vs. VDS



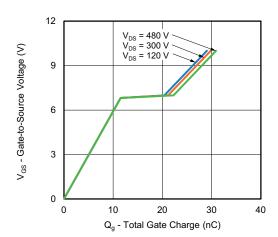


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

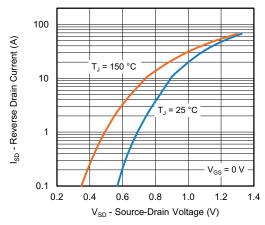


Fig. 8 - Typical Source-Drain Diode Forward Voltage

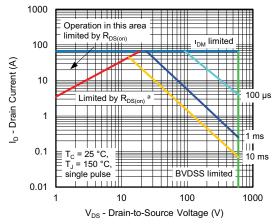


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

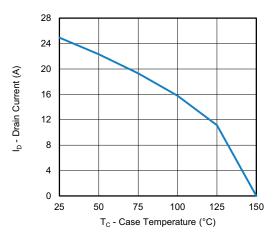


Fig. 10 - Maximum Drain Current vs. Case Temperature

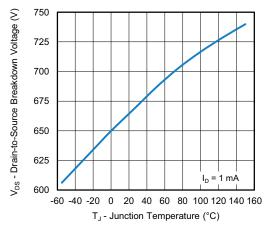


Fig. 11 - Temperature vs. Drain-to-Source Voltage



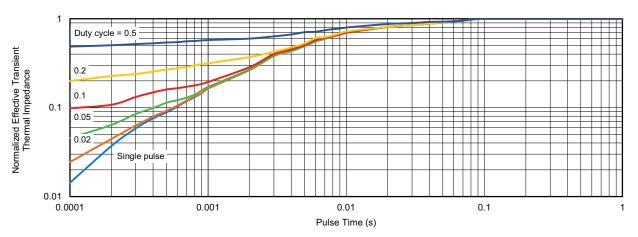


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

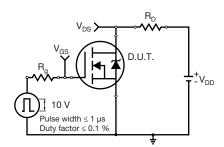


Fig. 13 - Switching Time Test Circuit

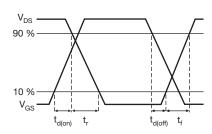


Fig. 14 - Switching Time Waveforms

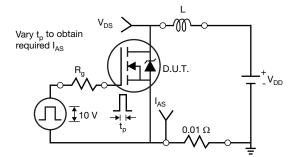


Fig. 15 - Unclamped Inductive Test Circuit

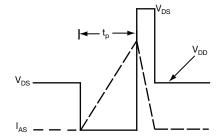


Fig. 16 - Unclamped Inductive Waveforms

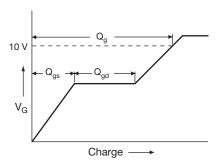


Fig. 17 - Basic Gate Charge Waveform

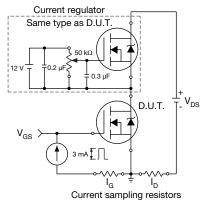
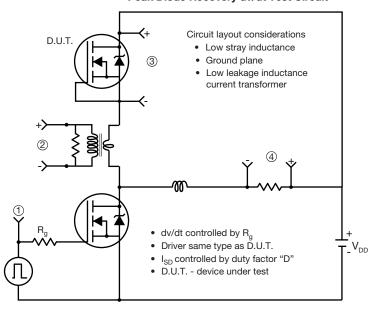


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



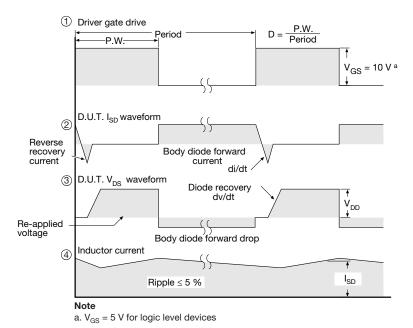


Fig. 19 - For N-Channel

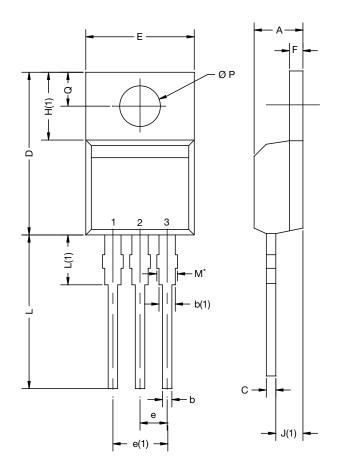
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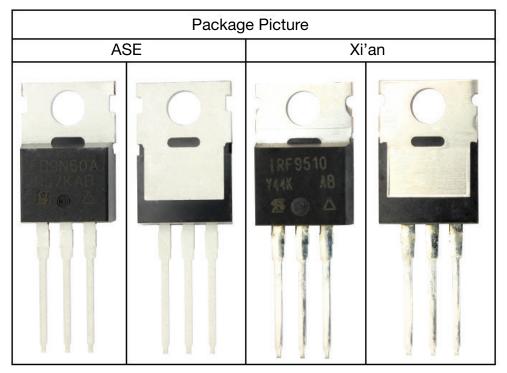
TO-220-1



DIM	MILLIM	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15- DWG: 603	0364-Rev. C, 1	14-Dec-15			

Note

• M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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